

PATENT
29347/990488#13/dwgs
2/13/03
HayesEXPEDITED PROCEDURE
GROUP ART UNIT 2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: JEUN et al.

Serial No.: 09/677,558

Title: SEMICONDUCTOR POWER
MODULE HAVING AN ELECTRICALLY
INSULATING HEAT SINK AND
METHOD OF MANUFACTURING THE
SAME

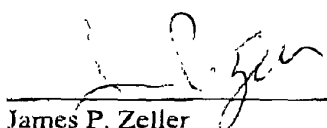
Filed: September 29, 2000

Group Art Unit: 2814

Examiner: DiLinh Nguyen

I hereby certify that this paper is being
facsimile transmitted to the United States
Patent and Trademark Office, Fax. No.
(703) 308-7722, on the date shown
below:

February 6, 2003


James P. Zeller
Reg. No. 28,491**REQUEST FOR APPROVAL OF DRAWING CHANGES**Commissioner for Patents
Washington, D.C. 20231

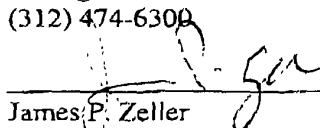
Dear Sir:

Applicants hereby request approval of the drawing changes indicated in red on the attached photocopies of Figures 1 and 3. The drawing changes are being made to show the heat sink (70) contacting the lead frame (40) as requested by the examiner in the official action of November 6, 2002. Support for the requested changes may be found throughout the specification, drawings and claims as originally filed. No new matter has been added.

Corrected formal drawings will be provided upon issuance of a notice of allowance in this application. The Commissioner is authorized to charge any deficiency in such payment or any payment required in connection with the filing of this response or to credit any overpayment to Deposit Account 13-2855. A duplicate copy of this paper is enclosed.

Respectfully submitted,
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By:


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February 6, 2003